

## Dual N-Channel 30-V (D-S) MOSFET, Common Drain

PRODUCT SUMMARY		
$V_{DS}$ (V)	$r_{DS(on)}$ ( $\Omega$ )	$I_D$ (A)
30	0.028 at $V_{GS} = 4.5$ V	8.3
	0.030 at $V_{GS} = 3.7$ V	8.0
	0.043 at $V_{GS} = 2.5$ V	6.7

### FEATURES

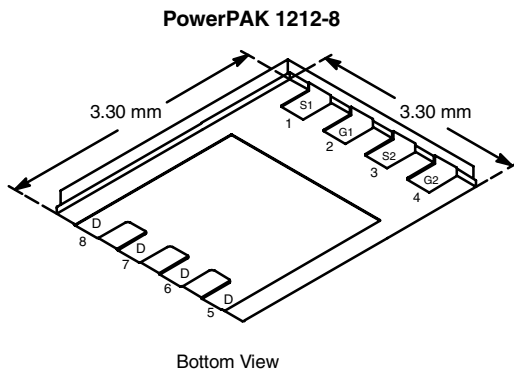
- TrenchFET<sup>®</sup> Power MOSFET
- New Low Thermal Resistance PowerPAK<sup>®</sup> Package with Low 1.07-mm Profile
- 3000-V ESD Protection



RoHS\*  
COMPLIANT

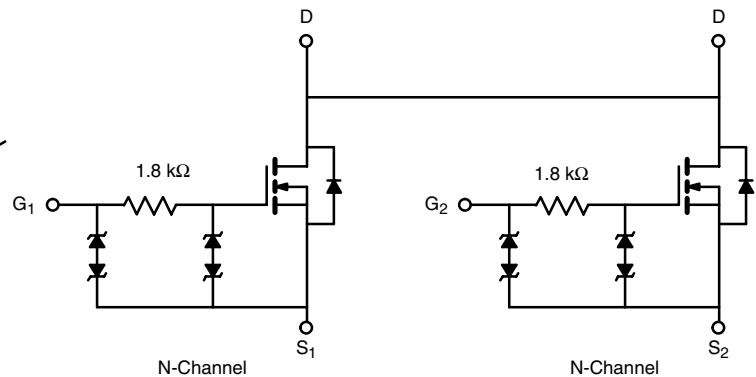
### APPLICATIONS

- Protection Switch for 1–2-Li-ion/LiP Batteries



Bottom View

Ordering Information: Si7902EDN-T1  
Si7902EDN-T1-E3 (Lead (Pb)-free)



ABSOLUTE MAXIMUM RATINGS $T_A = 25$ °C, unless otherwise noted					
Parameter	Symbol	10 secs	Steady State	Unit	
Drain-Source Voltage	$V_{DS}$	30		V	
Gate-Source Voltage	$V_{GS}$	$\pm 12$			
Continuous Drain Current ( $T_J = 150$ °C) <sup>a</sup>	$I_D$	$T_A = 25$ °C	8.3	5.6	A
		$T_A = 85$ °C	6.0	4.0	
Pulsed Drain Current	$I_{DM}$	40		A	
Continuous Source Current (Diode Conduction) <sup>a</sup>	$I_S$	2.7	1.3		
Maximum Power Dissipation <sup>a</sup>	$P_D$	$T_A = 25$ °C	3.2	1.5	W
		$T_A = 85$ °C	1.7	0.79	
Operating Junction and Storage Temperature Range	$T_J, T_{stg}$	– 55 to 150		°C	
Soldering Recommendations <sup>b,c</sup>		260			

THERMAL RESISTANCE RATINGS					
Parameter	Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient <sup>a</sup>	$R_{thJA}$	$t \leq 10$ sec	30	38	°C/W
		Steady State	65	82	
Maximum Junction-to-Case (Drain)	$R_{thJC}$	1.9	2.4		

Notes

a. Surface Mounted on 1" x 1" FR4 Board.

b. See Solder Profile (<http://www.vishay.com/ppg?73257>). The PowerPAK 1212-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.

c. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.

\* Pb containing terminations are not RoHS compliant, exemptions may apply



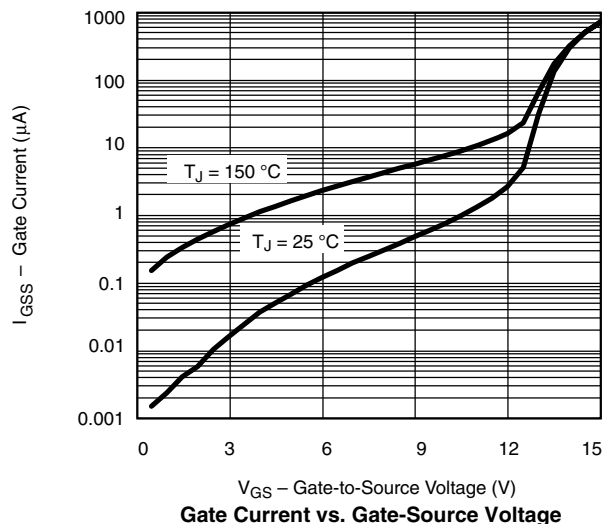
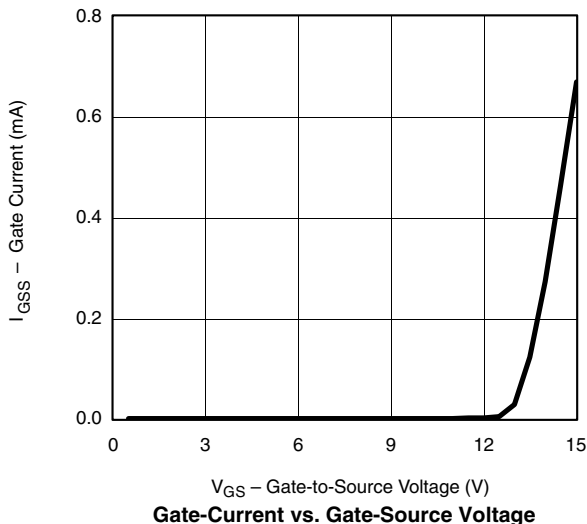
SPECIFICATIONS $T_J = 25\text{ }^\circ\text{C}$ , unless otherwise noted						
Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
<b>Static</b>						
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\text{ }\mu\text{A}$	0.60		1.5	V
Gate-Body Leakage	$I_{GSS}$	$V_{DS} = 0\text{ V}, V_{GS} = \pm 4.5\text{ V}$			$\pm 1$	$\mu\text{A}$
		$V_{DS} = 0\text{ V}, V_{GS} = \pm 12\text{ V}$			$\pm 10$	nA
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS} = 30\text{ V}, V_{GS} = 0\text{ V}$			1	$\mu\text{A}$
		$V_{DS} = 30\text{ V}, V_{GS} = 0\text{ V}, T_J = 85\text{ }^\circ\text{C}$			20	
On-State Drain Current <sup>a</sup>	$I_{D(on)}$	$V_{DS} \geq 5\text{ V}, V_{GS} = 4.5\text{ V}$	30			A
Drain-Source On-State Resistance <sup>a</sup>	$r_{DS(on)}$	$V_{GS} = 4.5\text{ V}, I_D = 8.3\text{ A}$		0.023	0.028	$\Omega$
		$V_{GS} = 3.7\text{ V}, I_D = 8.0\text{ A}$		0.025	0.030	
		$V_{GS} = 2.5\text{ V}, I_D = 3.0\text{ A}$		0.035	0.043	
Forward Transconductance <sup>a</sup>	$g_{fs}$	$V_{DS} = 15\text{ V}, I_D = 8.3\text{ A}$		26		S
Diode Forward Voltage <sup>a</sup>	$V_{SD}$	$I_S = 2.7\text{ A}, V_{GS} = 0\text{ V}$		0.75	1.2	V
<b>Dynamic<sup>b</sup></b>						
Total Gate Charge	$Q_g$	$V_{DS} = 15\text{ V}, V_{GS} = 4.5\text{ V}, I_D = 8.3\text{ A}$		10	15	nC
Gate-Source Charge	$Q_{gs}$			2.3		
Gate-Drain Charge	$Q_{gd}$			2.4		
Turn-On Delay Time	$t_{d(on)}$	$V_{DD} = 15\text{ V}, R_L = 15\text{ }\Omega$ $I_D = 1\text{ A}, V_{GEN} = 4.5\text{ V}, R_G = 6\text{ }\Omega$		0.9	1.5	$\mu\text{s}$
Rise Time	$t_r$			1.5	2.5	
Turn-Off Delay Time	$t_{d(off)}$			2.5	4.0	
Fall Time	$t_f$			2.5	4.0	

Notes

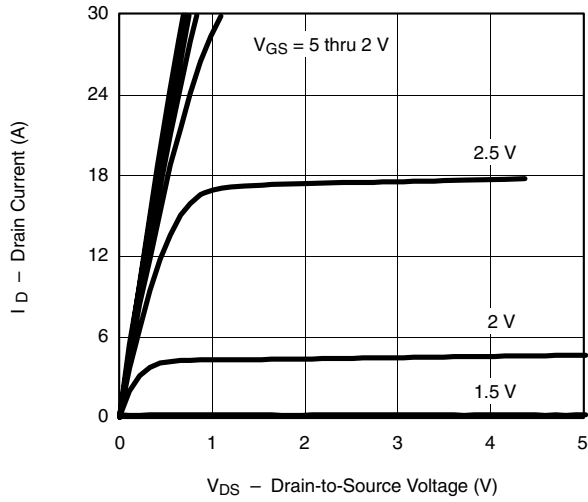
- a. Pulse test; pulse width  $\leq 300\text{ }\mu\text{s}$ , duty cycle  $\leq 2\%$ .
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

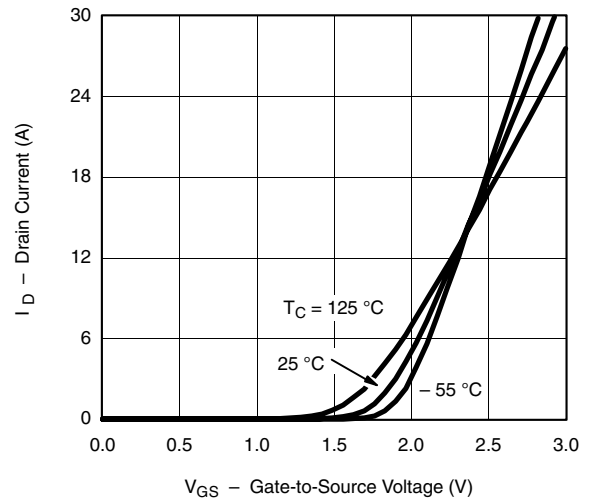
**TYPICAL CHARACTERISTICS**  $T_A = 25\text{ }^\circ\text{C}$ , unless otherwise noted



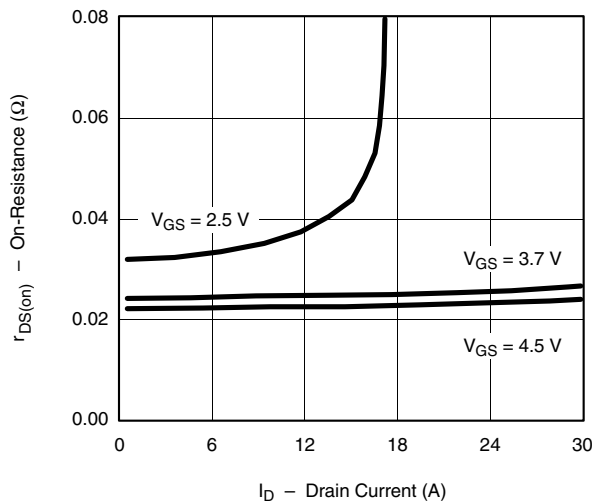
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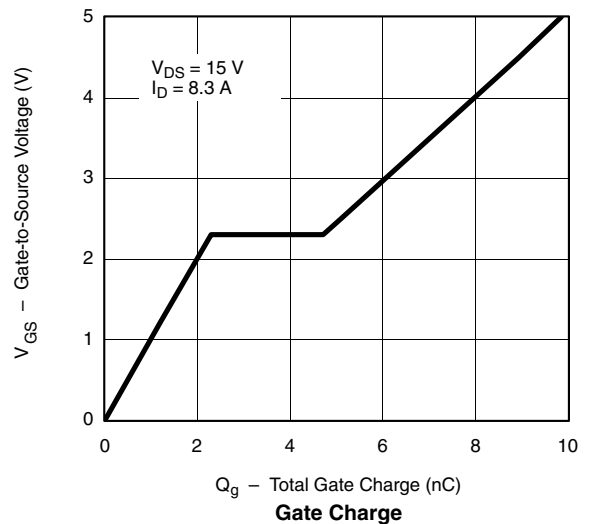
**Output Characteristics**



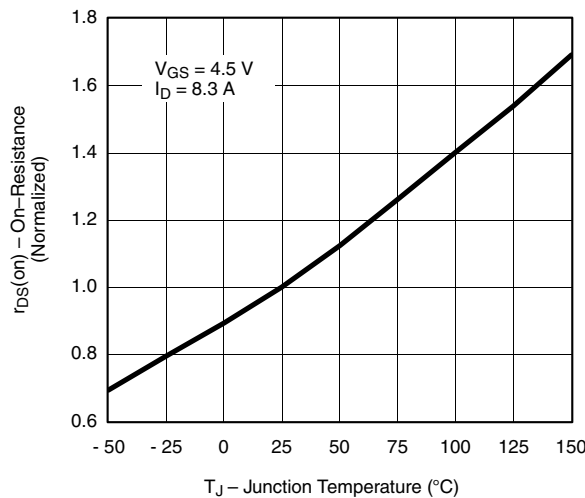
**Transfer Characteristics**



**On-Resistance vs. Drain Current**

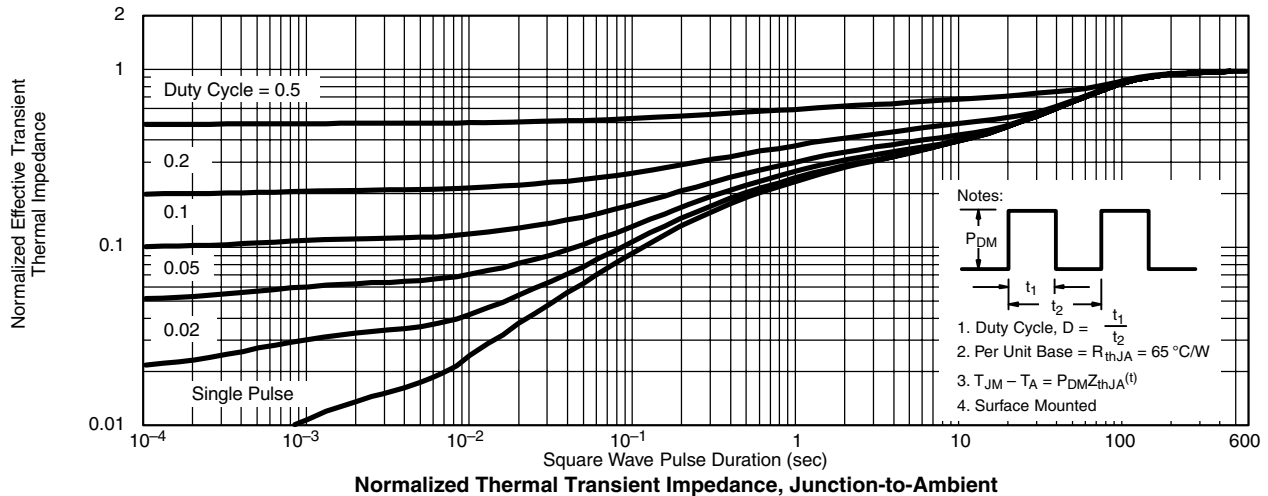
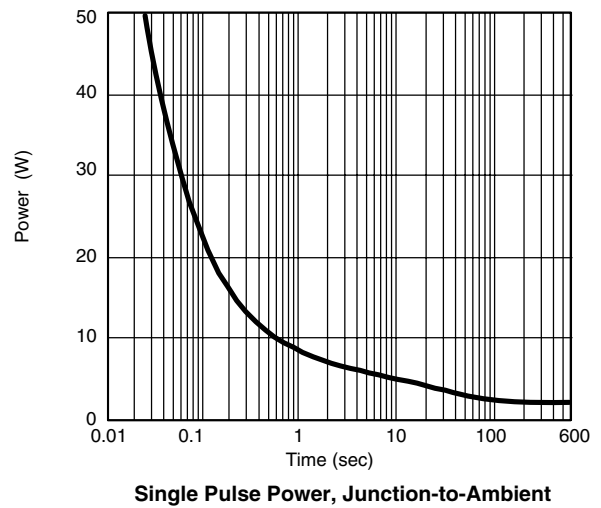
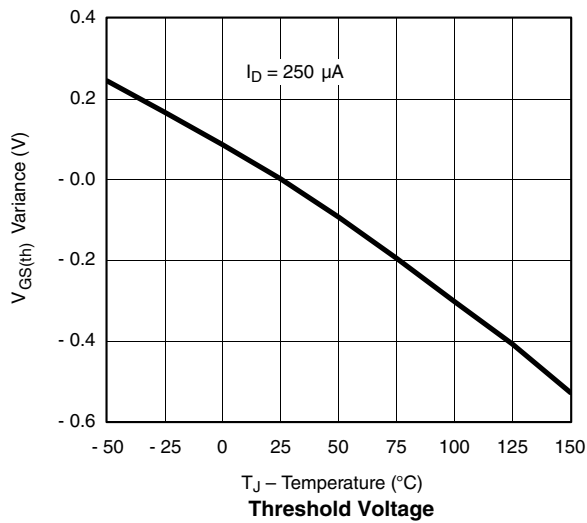
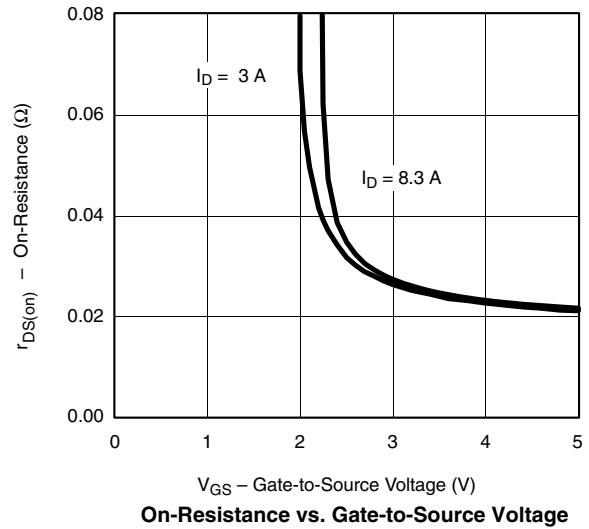
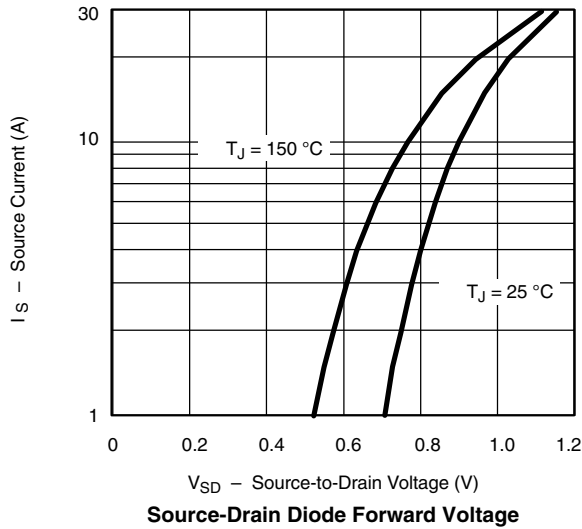


**Gate Charge**

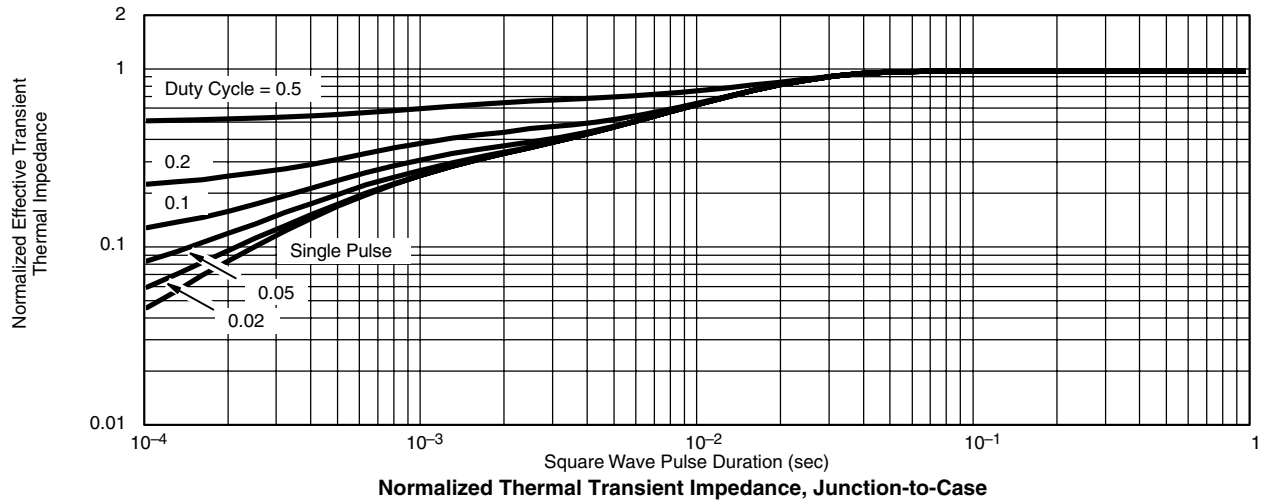


**On-Resistance vs. Junction Temperature**

**TYPICAL CHARACTERISTICS**  $T_A = 25\text{ }^\circ\text{C}$ , unless otherwise noted



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